<u>TOSHIBA</u>

TOSHIBA InGaA[®] LED

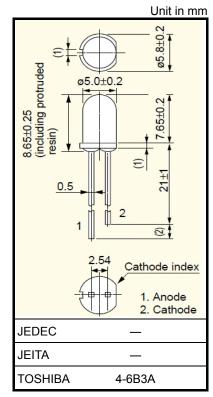
TLOU114P(F),TLSU114P(F),TLYU114P(F)

Panel Circuit Indicator

- Lead(Pb)-free products (lead: Sn-Ag-Cu)
- 5mm package
- InGaAℓP LED
- Without stand-offs
- All plastic mold type
- Colored lusterless lens
- Lineup: 3 colors (red, orange, yellow)
- Suitable for high-brightness and less electricity consumption.
- All plastic molded lens, provides an excellent on-off contrast ratio.
- Applications: Backlight, light for decoration, switches, various indicator, personal equipment

Lineup

Product	Color	Material		
TLOU114P(F)	Orange	InGaA{P		
TLSU114P(F)	Red	InGaA{P		
TLYU114P(F)	Yellow	InGaA{P		



Weight: 0.31g(Typ.)

Absolute Maximum	Ratings (Ta = 25°C)
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Product	Forward Current I _F (mA)	Reverse Voltage V _R (V)	Power Dissipation P _D (mW)	Operating Temperature T _{op} (°C)	Storage Temperature T _{sta} (°C)	
TLOU114P(F)	30	4	72	-20~75	-30~100	
TLSU114P(F)	30	4	72	-20~75	-30~100	
TLYU114P(F)	30	4	75	-20~75	-30~100	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Electrical and Optical characteristics (Ta = 25°C)

Product	Typ.Emission Wavelength		Luminous Intensity Iv		Forward Voltage VF			Reverse Current I _R			
	λ _p	Δλ	١F	Min	Тур.	١ _F	Тур.	Max	١ _F	Max	VR
TLOU114P(F)	(612)	15	20	85	250	20	2.0	2.4	20	50	4
TLSU114P(F)	(636)	17	20	85	250	20	2.0	2.4	20	50	4
TLYU114P(F)	(590)	13	20	47.6	130	20	2.1	2.5	20	50	4
Unit	n	m	mA	m	cd	mA	N	V	mA	μA	V

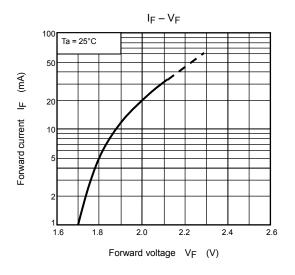
Precaution

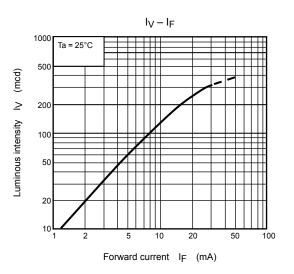
Please be careful of the followings

- Soldering temperature: 260°C max Soldering time: 3s max
- (Soldering portion of lead: up to 1.6mm from the body of the device)
- If the lead is formed, the lead should be formed up to 1.6mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.

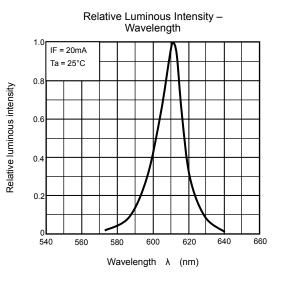
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TLOU114P(F)



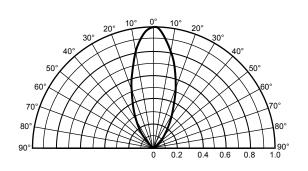


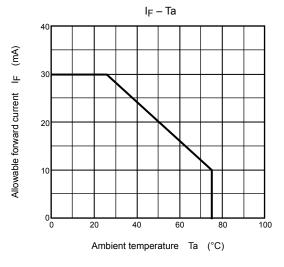
 $I_V - Tc$



Radiation Pattern

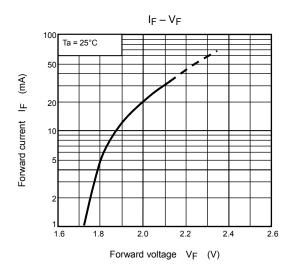
Ta = 25°C

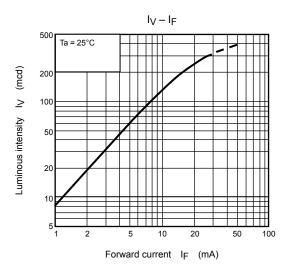




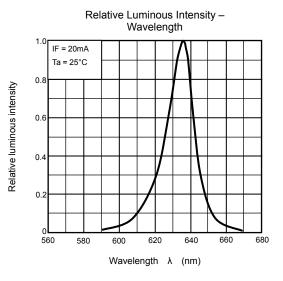
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TLSU114P(F)



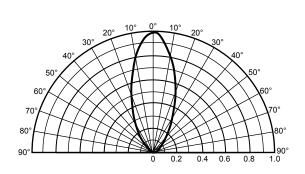


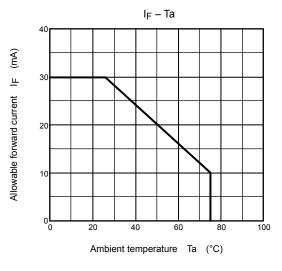
I_V – Tc 10 5 2 Relative luminous intensity 2 1.0 0.5 0.2 0.1 -25 0 25 50 75 100 Case temperature Tc (°C)



Radiation Pattern

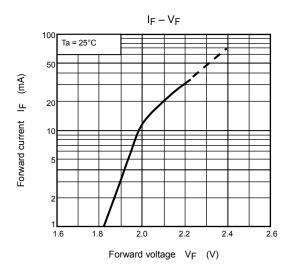
Ta = 25°C

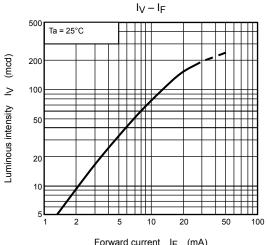




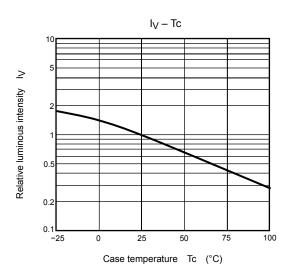
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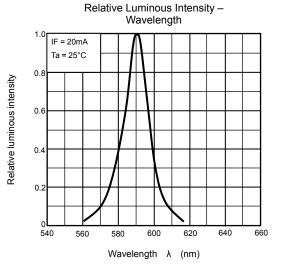
TLYU114P(F)





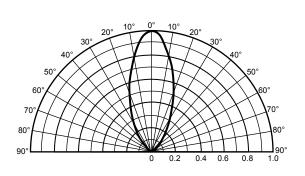
Forward current IF (mA)

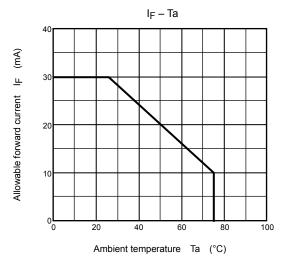




Radiation Pattern

Ta = 25°C





RESTRICTIONS ON PRODUCT USE

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- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
 In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.).These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in his document shall be made at the customer's own risk.
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- GaAs(Gallium Arsenide) is used in this product. The dust or vapor is harmful to the human body. Do not break, cut, crush or dissolve chemically.
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